



Parameter	Rating	Units
Load Voltage	400	V
Load Current	250	mA _{rms} / mA _{DC}
On-Resistance (max)	8	Ω

Features

- 3750V_{rms} Input/Output Isolation
 Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 8-Pin Package
- Machine Insertable, Wave Solderable
- Tape & Reel Versions Available

Applications

- Telecommunications
- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Hook Switch
- Dial Pulsing
- · Ground Start
- Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The PAA140 is a 400V, 250mA, 8Ω , dual normally open (1-Form-A) relay. This high performance leader provides a high peak load voltage handling capability combined with a very low on-resistance for specialized applications.

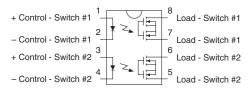
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

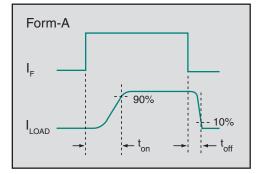
Ordering Information

Part #	Description
PAA140	8-Lead DIP (50/tube)
PAA140P	8-Lead Flatpack (50/tube)
PAA140PTR	8-PLead Flatpack (1000/Reel)
PAA140S	8-Lead Surface Mount (50/tube)
PAA140STR	8-Lead Surface Mount (1000/Reel)

Pin Configuration



Switching Characteristics of Normally Open Devices







Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	400	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	А
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	800	mW
Isolation Voltage, Input to Output	3750	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

¹ Derate linearly 1.33 mW / °C

² Derate linearly 6.67 mW / °C

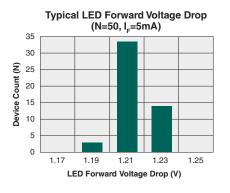
Electrical Characteristics @ 25°C

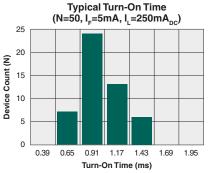
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics						I
Load Current						
Continuous *	-	ΙL	-	-	250	mA _{rms} / mA _{DC}
Peak	t=10ms	I _{LPK}	-	-	±500	mA _P
On-Resistance	I _L =250mA	R _{ON}	-	6	8	Ω
Off-State Leakage Current	V _L =400V _P	I _{LEAK}	-	-	1	μΑ
Switching Speeds						
Turn-On	1 - 5mA = 1 - 10V	t _{on}	-	-	3	
Turn-Off	I _F =5mA, V _L =10V	t _{off}	-	-	1	ms
Input Characteristics	1			r		I
Input Control Current to Activate	I _L =250mA	I _F	-	-	5	mA
Input Control Current to Deactivate	-	I _F	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μΑ
Common Characteristics						•
Capacitance Input to Output	-	C _{I/O}	-	3	-	pF

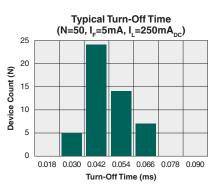
NOTE: If both poles operate simultaneously, then load current must be derated so that the package power dissipation value is not exceeded.

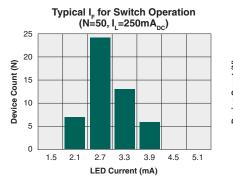


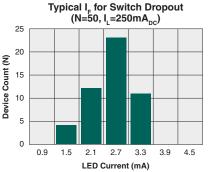
PERFORMANCE DATA @25°C (Unless Otherwise Noted)*

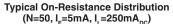


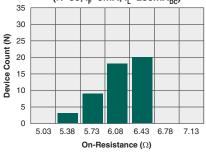


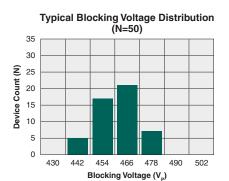


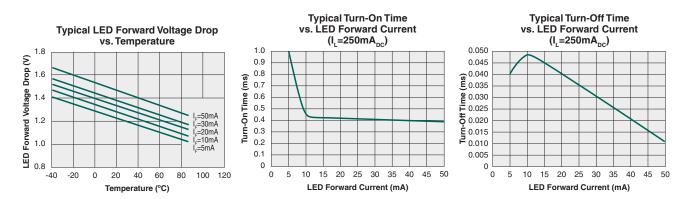








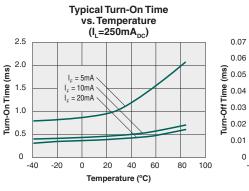


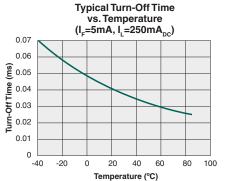


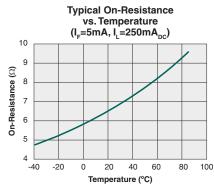
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

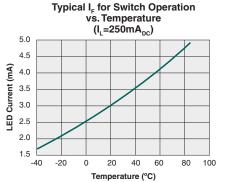


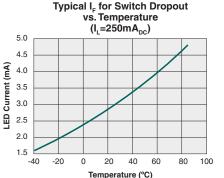
PERFORMANCE DATA @25°C (Unless Otherwise Noted)*



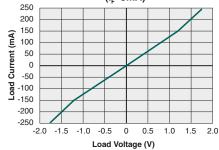






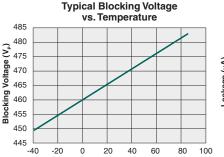


Typical Load Current vs. Load Voltage (I_F=5mA)



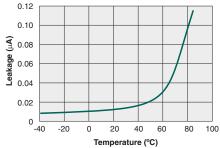
Maximum Load Current vs. Temperature 350 300 Load Current (mA) 250 I_ = 20mA = 10mA 200 = 5mA 150 100 -40 -20 0 20 40 60 80 100 120

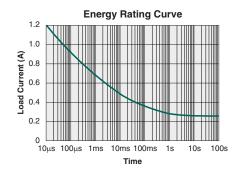
Temperature (°C)



Temperature (°C)

Typical Leakage vs. Temperature Measured Across Pins 5&6 or 7&8





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Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating	
PAA140 / PAA140S / PAA140P	MSL 1	

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
PAA140 / PAA140S	250°C for 30 seconds
PAA140P	260°C for 30 seconds

Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



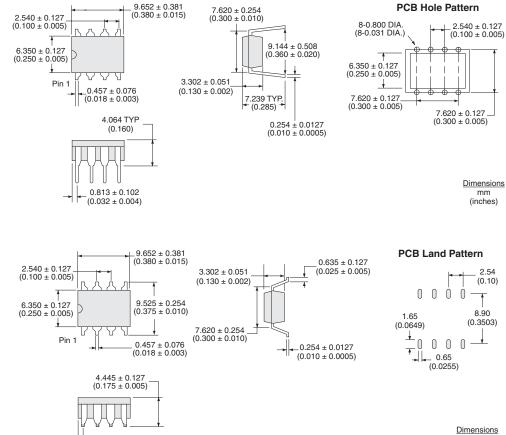
R09



Mechanical Dimensions

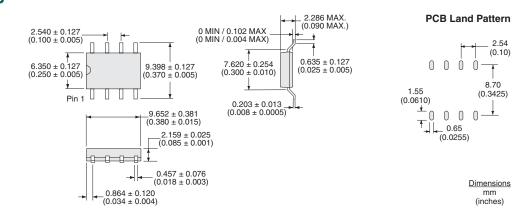
PAA140

PAA140S



mm (inches)

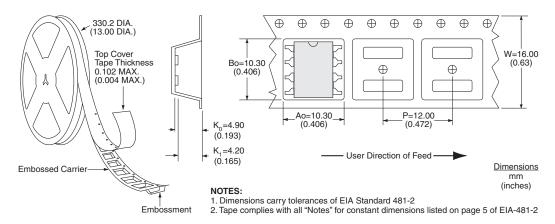
PAA140P



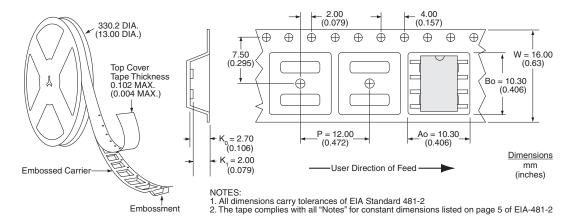
 0.813 ± 0.102 (0.032 ± 0.004)



PAA140STR Tape & Reel



PAA140PTR Tape & Reel



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